NTST30120CT, NTSJ30120CTG, NTSB30120CT-1G, NTSB30120CTG, NTSB30120CTT4G

Very Low Forward Voltage Trench-based Schottky Rectifier

Exceptionally Low $V_F = 0.50$ V at $I_F = 5$ A

Features

- Fine Lithography Trench–based Schottky Technology for Very Low Forward Voltage and Low Leakage
- Fast Switching with Exceptional Temperature Stability
- Low Power Loss and Lower Operating Temperature
- Higher Efficiency for Achieving Regulatory Compliance
- Low Thermal Resistance
- High Surge Capability
- These are Pb–Free Devices

Typical Applications

- Switching Power Supplies including Notebook / Netbook Adapters, ATX and Flat Panel Display
- High Frequency and DC–DC Converters
- Freewheeling and OR-ing diodes
- Reverse Battery Protection
- Instrumentation

Mechanical Characteristics

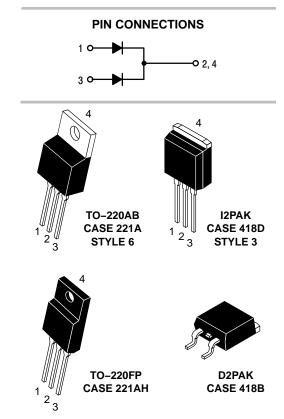
- Case: Epoxy, Molded
- Epoxy Meets Flammability Rating UL 94-0 @ 0.125 in
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Maximum for 10 sec



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VERY LOW FORWARD VOLT-AGE, LOW LEAKAGE SCHOT-TKY BARRIER RECTIFIERS 30 AMPERES, 120 VOLTS



ORDERING INFORMATION

See detailed ordering and shipping information on page 5 of this data sheet.

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MAXIMUM RATINGS

Rating		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	120	V
Average Rectified Forward Current (Rated V_R , T_C = 125°C)	Per device Per diode	I _{F(AV)}	30 15	A
Peak Repetitive Forward Current (Rated V_R , Square Wave, 20 kHz, $T_C = 130^{\circ}C$)	Per device Per diode	I _{FRM}	60 30	A
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)		I _{FSM}	150	A
Operating Junction Temperature		TJ	-40 to +150	°C
Storage Temperature		T _{stg}	-40 to +150	°C
Voltage Rate of Change (Rated V _R)		dv/dt	10,000	V/μs

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

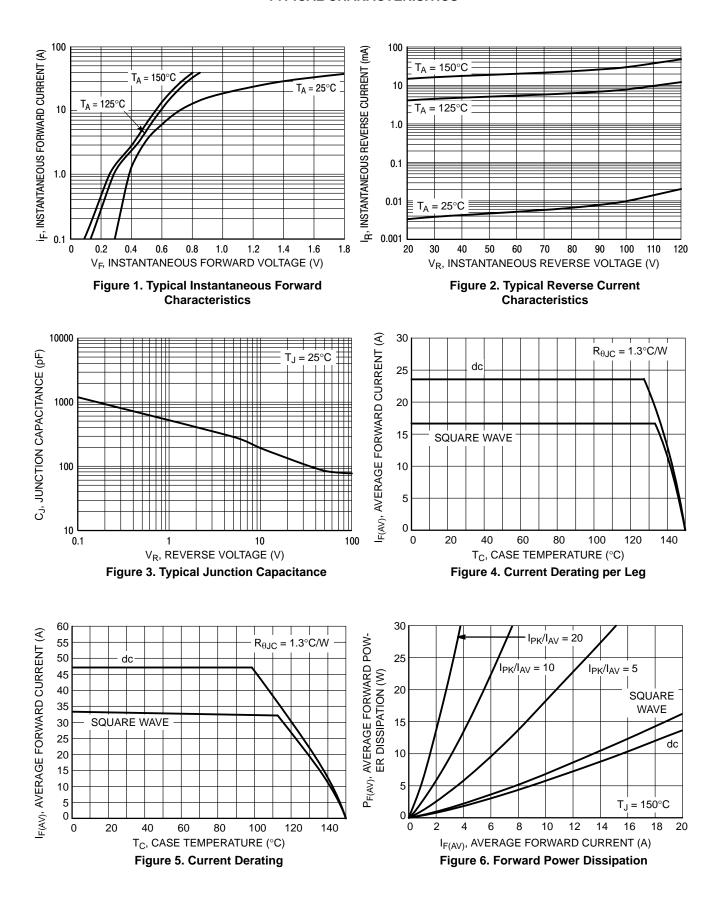
Rating	Symbol	NTST30120CTG NTSB30120CT-1G	NTSB30120CTG	NTSJ30120CTG	Unit
Maximum Thermal Resistance per Diode Junction-to-Case Junction-to-Ambient	$R_{ heta JC} \ R_{ heta JA}$	2.5 70	1.14 46.6	4.05 105	°C/W °C/W

ELECTRICAL CHARACTERISTICS (Per Leg unless otherwise noted)

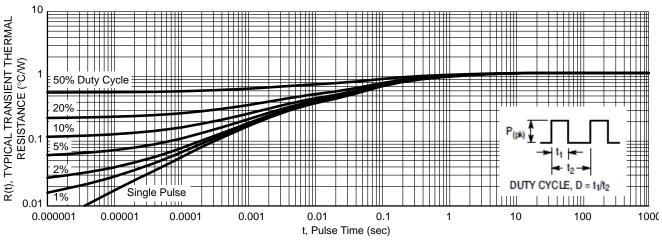
Rating	Symbol	Тур	Max	Unit
Maximum Instantaneous Forward Voltage (Note 1) $(I_F = 5 \text{ A}, T_J = 25^{\circ}\text{C})$ $(I_F = 7.5 \text{ A}, T_J = 25^{\circ}\text{C})$ $(I_F = 15 \text{ A}, T_J = 25^{\circ}\text{C})$	۷ _F	0.56 0.71 0.90	- - 1.08	V
$(I_F = 15 \text{ A}, T_J = 25 \text{ C})$ $(I_F = 5 \text{ A}, T_J = 125^{\circ}\text{C})$ $(I_F = 7.5 \text{ A}, T_J = 125^{\circ}\text{C})$ $(I_F = 15 \text{ A}, T_J = 125^{\circ}\text{C})$		0.50 0.60 0.68	- - 0.76	
Maximum Instantaneous Reverse Current (Note 1) $(V_R = 90 \text{ V}, T_J = 25^{\circ}\text{C})$ $(V_R = 90 \text{ V}, T_J = 125^{\circ}\text{C})$	I _R	16 11	-	μA mA
(Rated dc Voltage, $T_J = 25^{\circ}C$) (Rated dc Voltage, $T_J = 125^{\circ}C$)		_ 25	800 100	μA mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 1. Pulse Test: Pulse Width = $300 \ \mu$ s, Duty Cycle $\leq 2.0\%$

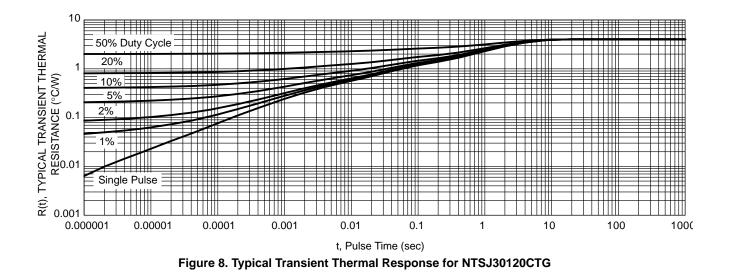
NTST30120CT, NTSJ30120CTG, NTSB30120CT-1G, NTSB30120CTG, NTSB30120CTT4G TYPICAL CHARACTERISITICS



NTST30120CT, NTSJ30120CTG, NTSB30120CT-1G, NTSB30120CTG, NTSB30120CTT4G **TYPICAL CHARACTERISITICS**







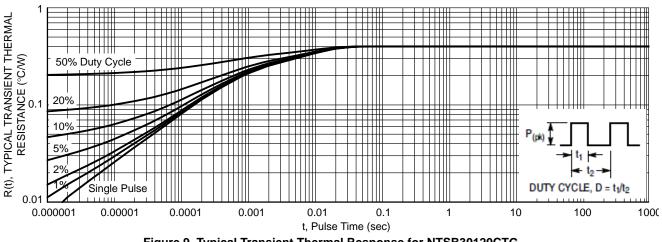


Figure 9. Typical Transient Thermal Response for NTSB30120CTG

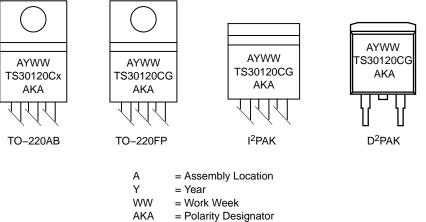
NTST30120CT, NTSJ30120CTG, NTSB30120CT–1G, NTSB30120CTG, NTSB30120CTT4G

ORDERING INFORMATION

Device	Package	Shipping [†]
NTST30120CTG	TO-220AB (Pb-Free)	50 Units / Rail
NTSJ30120CTG TO-220FP (Halide-Free)		50 Units / Rail
NTSB30120CT-1G	l ² PAK (Pb–Free)	50 Units / Rail
NTSB30120CTG	D ² PAK (Pb–Free)	50 Units / Rail
NTSB30120CTT4G	D ² PAK (Pb–Free)	800 / Tape & Reel

⁺For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MARKING DIAGRAMS



- x = G or H
- G = Pb–Free Package
- H = Halide–Free Package

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SCALE 1:1	B F C F	TO-22 CASE 22 ISSUE /	21A AK BEATING PLANE	2. CONT 3. DIMEN LEAI	ROLLING D NSION Z DE D IRREGUL/	AND TOLERAI IMENSION: IN FINES A ZONI ARITIES ARE A F102 DEVICE	ICHES E WHERE AL ALLOWED.	ANSI Y14.5№	
				·					
	A L	F			INC	HES	MILLIM	ETERS	
	0-			DIM	MIN.	MAX.	MIN.	MAX.	
	2 3			A	0.570	0.620	14.48	15.75	
······································	┟┰╁┰┛╺──╉			В	0.380	0.415	9.66	10.53	
⊢	┝┫╌╞┼┫╌╌╸			С	0.160	0.190	4.07	4.83	
		ΠΙ		D	0.025	0.038	0.64	0.96	
· z –	K			F	0.142	0.161	3.60	4.09	
	Î			G	0.095	0.105	2.42	2.66	
				н	0.110	0.161	2.80	4.10	
SEE NOTE #4	μ Ψ·	II I		J K	0.014	0.024	0.36 12.70	0.61 14.27	
v	R —				0.045	0.562	12.70	14.27	
G	J-	- -		N	0.190	0.000	4.83	5.33	
	D			Q	0.100	0.120	2.54	3.04	
	N -			R	0.080	0.110	2.04	2.79	
				s	0.045	0.055	1.15	1.41	
				T	0.235	0.255	5.97	6.47	
				U	0.000	0.050	0.00	1.27	
				v	0.045		1.15		
				z		0.080		2.04	
2. 3. 4. STYLE 5: PIN 1. 2. 3. 4. STYLE 9: PIN 1.	BASE PIN 1. COLLECTOR 2. EMITTER 3. COLLECTOR 4. STYLE 6: GATE PIN 1. DRAIN 2. SOURCE 3. DRAIN 4. STYLE 10 GATE PIN 1.	BASE EMITTER COLLECTOR EMITTER ANODE CATHODE CATHODE CATHODE CATHODE	2. 3. 4. STYLE 7: PIN 1. 2. 3. 4. STYLE 11: PIN 1.		=	2. MA 3. GA 4. MA STYLE 8: PIN 1. CA 2. AN 3. EX 4. AN STYLE 12: PIN 1. MA	in terminal Thode Dde Ternal Trip Dde In terminal	2 2 /DELAY .1	
3.	EMITTER 3.	SOURCE DRAIN SOURCE	3.	SOURCE GATE SOURCE		3. GA	in terminal Te It connecti		

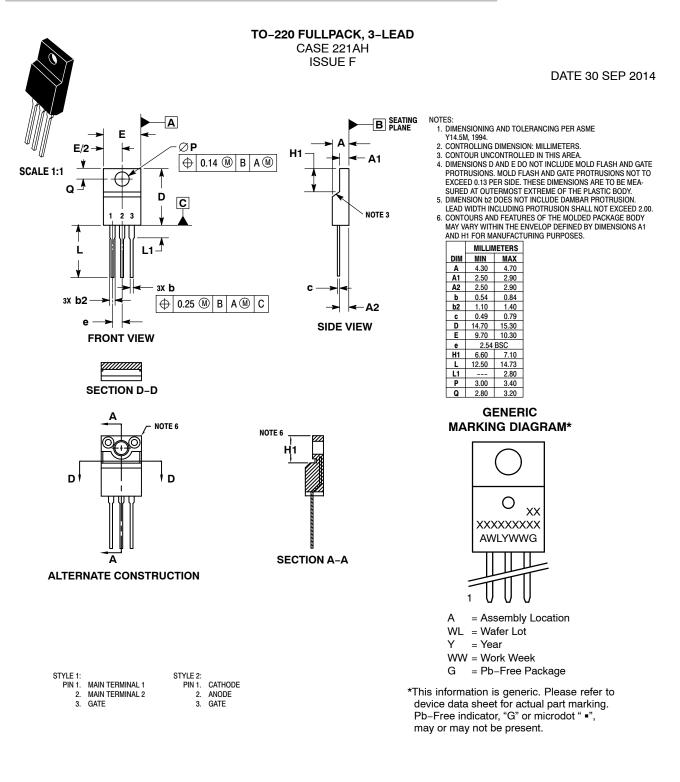
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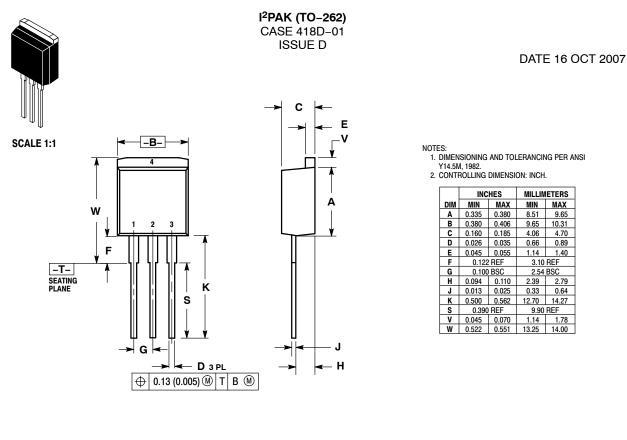




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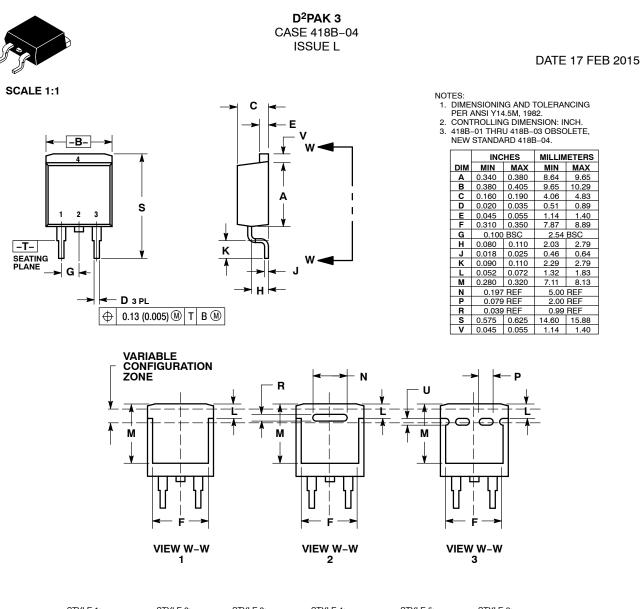




STYLE 1:	STYLE 2:	STYLE 3:	STYLE 4:
PIN 1. BASE	PIN 1. GATE	PIN 1. ANODE	PIN 1. GATE
2. COLLECTOR	2. DRAIN	2. CATHODE	2. COLLECTOR
3. EMITTER	3. SOURCE	3. ANODE	3. EMITTER
 COLLECTOR 	4. DRAIN	4. CATHODE	4. COLLECTOR

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STYLE 1:	STYLE 2:	STYLE 3:	STYLE 4:	STYLE 5:	STYLE 6:
PIN 1. BASE	PIN 1. GATE	PIN 1. ANODE	PIN 1. GATE	PIN 1. CATHODE	PIN 1. NO CONNECT
2. COLLECTOR	2. DRAIN	2. CATHODE	2. COLLECTOR	2. ANODE	2. CATHODE
3. EMITTER	SOURCE	ANODE	3. EMITTER	3. CATHODE	3. ANODE
4. COLLECTOR	4. DRAIN	4. CATHODE	4. COLLECTOR	4. ANODE	4. CATHODE

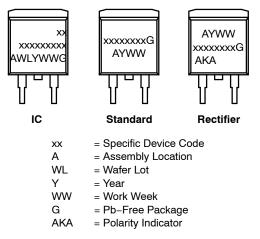
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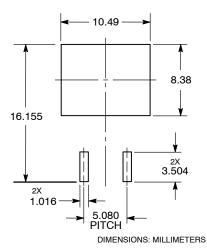
DATE 17 FEB 2015

GENERIC MARKING DIAGRAM*



*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present.

SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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